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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

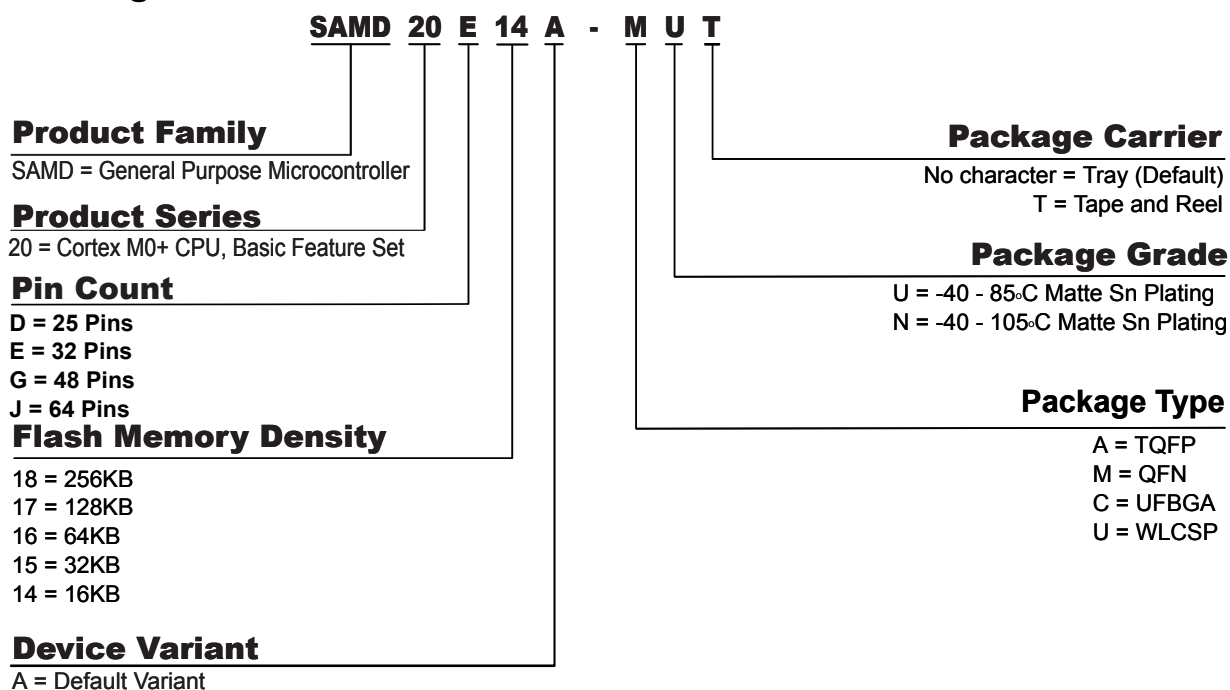
| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | ARM® Cortex®-M0+ |
| Core Size | 32-Bit Single-Core |
| Speed | 48MHz |
| Connectivity | I ² C, SPI, UART/USART |
| Peripherals | Brown-out Detect/Reset, POR, WDT |
| Number of I/O | 26 |
| Program Memory Size | 16KB (16K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 2K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.62V ~ 3.6V |
| Data Converters | A/D 10x12b; D/A 1x10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 32-TQFP |
| Supplier Device Package | 32-TQFP (7x7) |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/atsamd20e14b-au |

- Up to five 16-bit Timer/Counters (TC), configurable as either:
 - One 16-bit TC with two compare/capture channels
 - One 8-bit TC with two compare/capture channels
 - One 32-bit TC with two compare/capture channels, by using two TCs
- 32-bit Real Time Counter (RTC) with clock/calendar function
- Watchdog Timer (WDT)
- CRC-32 generator
- Up to six Serial Communication Interfaces (SERCOM), each configurable to operate as either:
 - USART with full-duplex and single-wire half-duplex configuration
 - Inter-Integrated Circuit (I²C) up to 400kHz
 - Serial Peripheral Interface (SPI)
- One 12-bit, 350ksps Analog-to-Digital Converter (ADC) with up to 20 channels
 - Differential and single-ended input
 - 1/2x to 16x programmable gain stage
 - Automatic offset and gain error compensation
 - Oversampling and decimation in hardware to support 13-, 14-, 15- or 16-bit resolution
- 10-bit, 350ksps Digital-to-Analog Converter (DAC)
- Two Analog Comparators (AC) with window compare function
- Peripheral Touch Controller (PTC)
 - 256-Channel capacitive touch and proximity sensing
- I/O
 - Up to 52 programmable I/O pins
- Packages
 - 64-pin TQFP, QFN
 - 64-ball UFBGA
 - 48-pin TQFP, QFN
 - 45-ball WLCSP
 - 32-pin TQFP, QFN
- Operating Voltage
 - 1.62V – 3.63V
- Power Consumption
 - Down to 70µA/MHz in active mode
 - Down to 8µA running the Peripheral Touch Controller

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3. Ordering Information



3.1. SAM D20E

| Ordering Code | FLASH (bytes) | SRAM (bytes) | Package | Carrier Type |
|------------------|---------------|--------------|---------|--------------|
| ATSAMD20E14A-AU | 16K | 2K | TQFP32 | Tray |
| ATSAMD20E14A-AUT | | | | Tape & Reel |
| ATSAMD20E14A-AN | | | | Tray |
| ATSAMD20E14A-ANT | | | | Tape & Reel |
| ATSAMD20E14A-MU | | | QFN32 | Tray |
| ATSAMD20E14A-MUT | | | | Tape & Reel |
| ATSAMD20E14A-MN | | | | Tray |
| ATSAMD20E14A-MNT | | | | Tape & Reel |

3.2. SAM D20G

| Ordering Code | FLASH (bytes) | SRAM (bytes) | Package | Carrier Type |
|------------------|---------------|--------------|---------|--------------|
| ATSAMD20G14A-AU | 16K | 2K | TQFP32 | Tray |
| ATSAMD20G14A-AUT | | | | Tape & Reel |
| ATSAMD20G14A-AN | | | | Tray |
| ATSAMD20G14A-ANT | | | | Tape & Reel |
| ATSAMD20G14A-MU | | | QFN32 | Tray |
| ATSAMD20G14A-MUT | | | | Tape & Reel |
| ATSAMD20G14A-MN | | | | Tray |
| ATSAMD20G14A-MNT | | | | Tape & Reel |
| ATSAMD20G15A-AU | 32K | 4K | TQFP48 | Tray |
| ATSAMD20G15A-AUT | | | | Tape & Reel |
| ATSAMD20G15A-AN | | | | Tray |
| ATSAMD20G15A-ANT | | | | Tape & Reel |
| ATSAMD20G15A-MU | | | QFN48 | Tray |
| ATSAMD20G15A-MUT | | | | Tape & Reel |
| ATSAMD20G15A-MN | | | | Tray |
| ATSAMD20G15A-MNT | | | | Tape & Reel |
| ATSAMD20G16A-AU | 64K | 8K | TQFP48 | Tray |
| ATSAMD20G16A-AUT | | | | Tape & Reel |
| ATSAMD20G16A-AN | | | | Tray |
| ATSAMD20G16A-ANT | | | | Tape & Reel |
| ATSAMD20G16A-MU | | | QFN48 | Tray |
| ATSAMD20G16A-MUT | | | | Tape & Reel |
| ATSAMD20G16A-MN | | | | Tray |
| ATSAMD20G16A-MNT | | | | Tape & Reel |

| Ordering Code | FLASH (bytes) | SRAM (bytes) | Package | Carrier Type |
|------------------|---------------|--------------|---------|--------------|
| ATSAMD20J15A-AU | 32K | 4K | TQFP64 | Tray |
| ATSAMD20J15A-AUT | | | | Tape & Reel |
| ATSAMD20J15A-AN | | | | Tray |
| ATSAMD20J15A-ANT | | | | Tape & Reel |
| ATSAMD20J15A-MU | | | QFN64 | Tray |
| ATSAMD20J15A-MUT | | | | Tape & Reel |
| ATSAMD20J15A-MN | | | | Tray |
| ATSAMD20J15A-MNT | | | | Tape & Reel |
| ATSAMD20J16A-AU | 64K | 8K | TQFP64 | Tray |
| ATSAMD20J16A-AUT | | | | Tape & Reel |
| ATSAMD20J16A-AN | | | | Tray |
| ATSAMD20J16A-ANT | | | | Tape & Reel |
| ATSAMD20J16A-MU | | | QFN64 | Tray |
| ATSAMD20J16A-MUT | | | | Tape & Reel |
| ATSAMD20J16A-MN | | | | Tray |
| ATSAMD20J16A-MNT | | | | Tape & Reel |
| ATSAMD20J16A-CU | | | UFBGA64 | Tray |
| ATSAMD20J16A-CUT | | | | Tape & Reel |
| ATSAMD20J17A-AU | 128K | 16K | TQFP64 | Tray |
| ATSAMD20J17A-AUT | | | | Tape & Reel |
| ATSAMD20J17A-AN | | | | Tray |
| ATSAMD20J17A-ANT | | | | Tape & Reel |
| ATSAMD20J17A-MU | | | QFN64 | Tray |
| ATSAMD20J17A-MUT | | | | Tape & Reel |
| ATSAMD20J17A-MN | | | | Tray |
| ATSAMD20J17A-MNT | | | | Tape & Reel |
| ATSAMD20J17A-CU | | | UFBGA64 | Tray |
| ATSAMD20J17A-CUT | | | | Tape & Reel |

| Ordering Code | FLASH (bytes) | SRAM (bytes) | Package | Carrier Type |
|------------------|---------------|--------------|---------|--------------|
| ATSAMD20J18A-AU | 256K | 32K | TQFP64 | Tray |
| ATSAMD20J18A-AUT | | | | Tape & Reel |
| ATSAMD20J18A-AN | | | | Tray |
| ATSAMD20J18A-ANT | | | | Tape & Reel |
| ATSAMD20J18A-MU | | | QFN64 | Tray |
| ATSAMD20J18A-MUT | | | | Tape & Reel |
| ATSAMD20J18A-MN | | | | Tray |
| ATSAMD20J18A-MNT | | | | Tape & Reel |
| ATSAMD20J18A-CU | | | UFBGA64 | Tray |
| ATSAMD20J18A-CUT | | | | Tape & Reel |

3.4. Device Identification

The DSU - Device Service Unit peripheral provides the Device Selection bits in the Device Identification register (DID.DEVSEL) in order to identify the device by software. The device variants have a reset value of DID=0x1001drxx, with the LSB identifying the die number ('d'), the die revision ('r') and the device selection ('xx').

Table 3-1. Device Identification Values

| Device Variant | DID.DEVSEL | Device ID (DID) |
|----------------|------------|-----------------|
| SAMD20J18C | 0x00 | 0x10001300 |
| SAMD20J18A | 0x00 | 0x10001300 |
| SAMD20J17A | 0x01 | 0x10001301 |
| SAMD20J16A | 0x02 | 0x10001302 |
| SAMD20J15A | 0x03 | 0x10001303 |
| SAMD20J14A | 0x04 | 0x10001304 |
| SAMD20G18A | 0x05 | 0x10001305 |
| SAMD20G17A | 0x06 | 0x10001306 |
| SAMD20G16A | 0x07 | 0x10001307 |
| SAMD20G15A | 0x08 | 0x10001308 |
| SAMD20G14A | 0x09 | 0x10001309 |
| SAMD20E18A | 0x0A | 0x1000130A |
| SAMD20E17A | 0x0B | 0x1000130B |
| SAMD20E16A | 0x0C | 0x1000130C |
| SAMD20E15A | 0x0D | 0x1000130D |

| Device Variant | DID.DEVSEL | Device ID (DID) |
|----------------|-------------|-----------------|
| SAMD20E14A | 0x0E | 0x1000130E |
| Reserved | 0x0F | |
| SAMD20G18U | 0x10 | 0x10001310 |
| SAMD20G17U | 0x11 | 0x10001311 |
| Reserved | 0x12 - 0xFF | |

Note: The device variant (last letter of the ordering number) is independent of the die revision (DSU.DID.REVISION): The device variant denotes functional differences, whereas the die revision marks evolution of the die. The device variant denotes functional differences, whereas the die revision marks evolution of the die.

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- The System Timer is a 24-bit timer that extends the functionality of both the processor and the NVIC. Refer to the Cortex-M0+ Technical Reference Manual for details (www.arm.com).
- Nested Vectored Interrupt Controller (NVIC)
 - External interrupt signals connect to the NVIC, and the NVIC prioritizes the interrupts. Software can set the priority of each interrupt. The NVIC and the Cortex-M0+ processor core are closely coupled, providing low latency interrupt processing and efficient processing of late arriving interrupts. Refer to [Nested Vector Interrupt Controller](#) and the Cortex-M0+ Technical Reference Manual for details (www.arm.com).
- System Control Block (SCB)
 - The System Control Block provides system implementation information, and system control. This includes configuration, control, and reporting of the system exceptions. Refer to the Cortex-M0+ Devices Generic User Guide for details (www.arm.com).
- Micro Trace Buffer (MTB)
 - The CoreSight MTB-M0+ (MTB) provides a simple execution trace capability to the Cortex-M0+ processor. Refer to section [Micro Trace Buffer](#) and the CoreSight MTB-M0+ Technical Reference Manual for details (www.arm.com).

7.1.3. Cortex-M0+ Address Map

Table 7-2. Cortex-M0+ Address Map

| Address | Peripheral |
|---------------------------------------|---|
| 0xE000E000 | System Control Space (SCS) |
| 0xE000E010 | System Timer (SysTick) |
| 0xE000E100 | Nested Vectored Interrupt Controller (NVIC) |
| 0xE000ED00 | System Control Block (SCB) |
| 0x41006000 (see also Product Mapping) | Micro Trace Buffer (MTB) |

7.1.4. I/O Interface

7.1.4.1. Overview

Because accesses to the AMBA® AHB-Lite™ and the single cycle I/O interface can be made concurrently, the Cortex-M0+ processor can fetch the next instructions while accessing the I/Os. This enables single cycle I/O accesses to be sustained for as long as needed. Refer to *CPU Local Bus* for more information.

7.1.4.2. Description

Direct access to PORT registers.

7.2. Nested Vector Interrupt Controller

7.2.1. Overview

The Nested Vectored Interrupt Controller (NVIC) in the SAM D20 supports 32 interrupt lines with four different priority levels. For more details, refer to the Cortex-M0+ Technical Reference Manual (www.arm.com).

7.2.2. Interrupt Line Mapping

Each of the 28 interrupt lines is connected to one peripheral instance, as shown in the table below. Each peripheral can have one or more interrupt flags, located in the peripheral's Interrupt Flag Status and Clear

7.4. High-Speed Bus System

7.4.1. Features

High-Speed Bus Matrix has the following features:

- Symmetric crossbar bus switch implementation
- Allows concurrent accesses from different masters to different slaves
- 32-bit data bus
- Operation at a one-to-one clock frequency with the bus masters

7.4.2. Configuration

Table 7-4. Bus Matrix Masters

| Bus Matrix Masters | Master ID |
|-----------------------------|-----------|
| CM0+ - Cortex M0+ Processor | 0 |
| DSU - Device Service Unit | 1 |

Table 7-5. Bus Matrix Slaves

| Bus Matrix Slaves | Slave ID |
|-----------------------|----------|
| Internal Flash Memory | 0 |
| AHB-APB Bridge A | 1 |
| AHB-APB Bridge B | 2 |
| AHB-APB Bridge C | 3 |

7.5. AHB-APB Bridge

The AHB-APB bridge is an AHB slave, providing an interface between the high-speed AHB domain and the low-power APB domain. It is used to provide access to the programmable control registers of peripherals (see *Product Mapping*).

AHB-APB bridge is based on AMBA APB Protocol Specification V2.0 (ref. as APB4) including:

- Wait state support
- Error reporting
- Transaction protection
- Sparse data transfer (byte, half-word and word)

Additional enhancements:

- Address and data cycles merged into a single cycle
- Sparse data transfer also apply to read access

to operate the AHB-APB bridge, the clock (CLK_HPBBx_AHB) must be enabled. See *PM – Power Manager* for details.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bit 1 – DSU

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bit 1 – DSU

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

7.7.3. PAC2 Register Description

7.7.3.1. Write Protect Clear

Name: WPCLR
Offset: 0x00
Reset: 0x00800000
Property: –

| | | | | | | | | |
|--------|---------|---------|---------|---------|---------|---------|-------|-----|
| Bit | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 |
| | | | | | | | | |
| Access | | | | | | | | |
| Reset | | | | | | | | |
| Bit | 23 | 22 | 21 | 20 | 19 | 18 | 17 | 16 |
| | | | | | PTC | DAC | AC | ADC |
| Access | | | | | R/W | R/W | R/W | R/W |
| Reset | | | | | 0 | 0 | 0 | 0 |
| Bit | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | TC7 | TC6 | TC5 | TC4 | TC3 | TC2 | TC1 | TC0 |
| Access | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Bit | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | SERCOM5 | SERCOM4 | SERCOM3 | SERCOM2 | SERCOM1 | SERCOM0 | EVSYS | |
| Access | R/W | R/W | R/W | R/W | R/W | R/W | R/W | |
| Reset | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |

Bit 19 – PTC

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bit 18 – DAC

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bit 17 – AC

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bit 16 – ADC

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bits 15,14,13,12,11,10,9,8 – TCx

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bits 7,6,5,4,3,2 – SERCOMx

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

Bit 1 – EVSYS

Writing a zero to these bits has no effect.

Writing a one to these bits will clear the Write Protect bit for the corresponding peripherals.

| Value | Description |
|-------|-------------------------------|
| 0 | Write-protection is disabled. |
| 1 | Write-protection is enabled. |

8. Packaging Information

8.1. Thermal Considerations

Related Links

[Junction Temperature](#) on page 39

8.1.1. Thermal Resistance Data

The following *table* summarizes the thermal resistance data depending on the package.

Table 8-1. Thermal Resistance Data

| Package Type | θ_{JA} | θ_{JC} |
|---------------|---------------|---------------|
| 32-pin TQFP | 68.0°C/W | 25.8°C/W |
| 48-pin TQFP | 78.8°C/W | 12.3°C/W |
| 64-pin TQFP | 66.7°C/W | 11.9°C/W |
| 32-pin QFN | 37.2°C/W | 13.1°C/W |
| 48-pin QFN | 33.0°C/W | 11.4°C/W |
| 64-pin QFN | 33.5°C/W | 11.2°C/W |
| 64-ball UFBGA | 67.4°C/W | 12.4°C/W |
| 45-ball WLCSP | 37.0°C/W | 0.36°C/W |

8.1.2. Junction Temperature

The average chip-junction temperature, T_J , in °C can be obtained from the following:

1. $T_J = T_A + (P_D \times \theta_{JA})$
2. $T_J = T_A + (P_D \times (\theta_{HEATSINK} + \theta_{JC}))$

where:

- θ_{JA} = Package thermal resistance, Junction-to-ambient (°C/W), see Thermal Resistance Data
- θ_{JC} = Package thermal resistance, Junction-to-case thermal resistance (°C/W), see Thermal Resistance Data
- $\theta_{HEATSINK}$ = Thermal resistance (°C/W) specification of the external cooling device
- P_D = Device power consumption (W)
- T_A = Ambient temperature (°C)

From the first equation, the user can derive the estimated lifetime of the chip and decide if a cooling device is necessary or not. If a cooling device is to be fitted on the chip, the second equation should be used to compute the resulting average chip-junction temperature T_J in °C.

Related Links

[Thermal Considerations](#) on page 39

8.2. Package Drawings

8.2.1. 64 pin TQFP

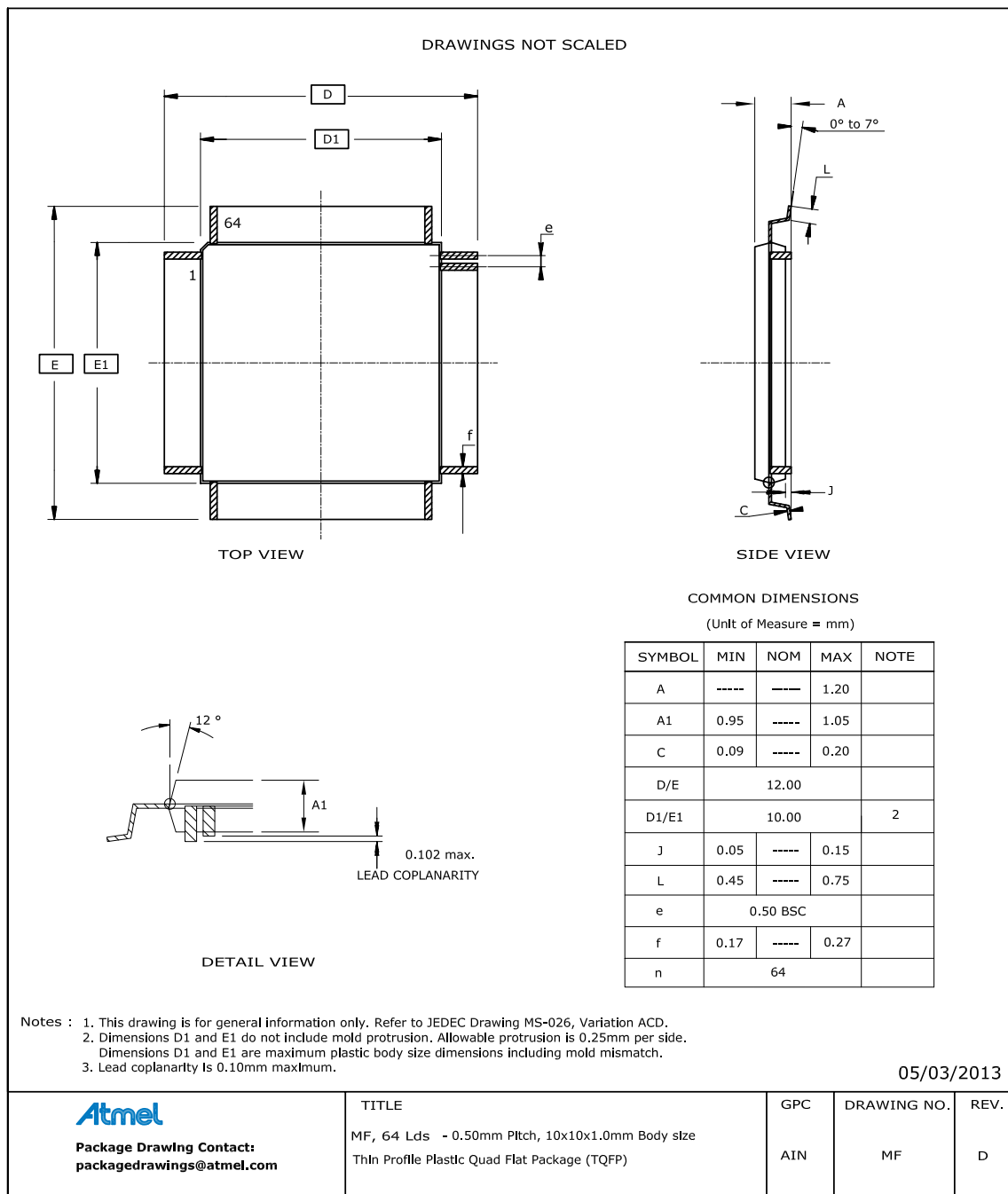


Table 8-2. Device and Package Maximum Weight

| | |
|-----|----|
| 300 | mg |
|-----|----|

Table 8-3. Package Characteristics

| | |
|----------------------------|------|
| Moisture Sensitivity Level | MSL3 |
|----------------------------|------|

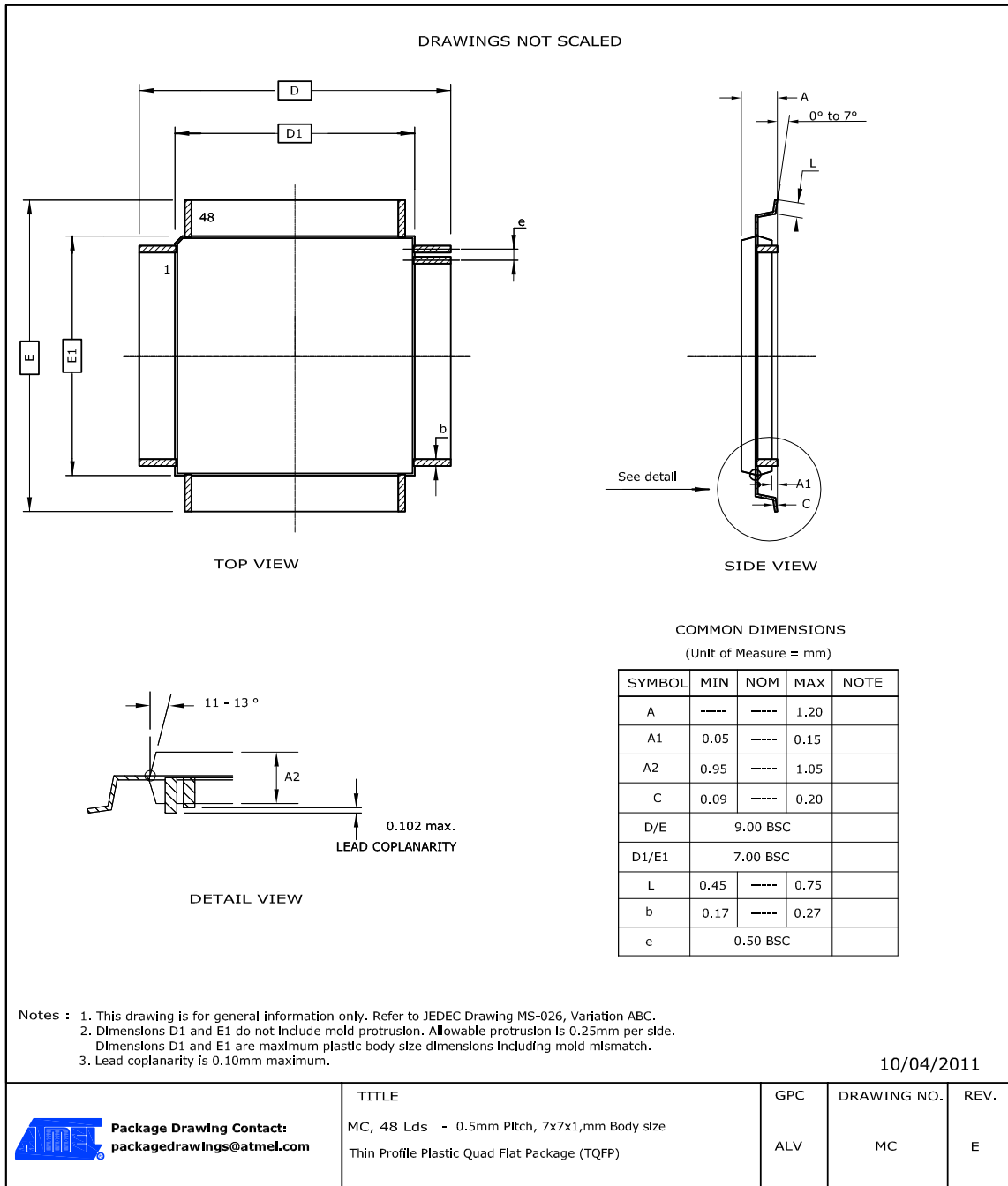
Table 8-9. Package Characteristics

| | |
|----------------------------|------|
| Moisture Sensitivity Level | MSL3 |
|----------------------------|------|

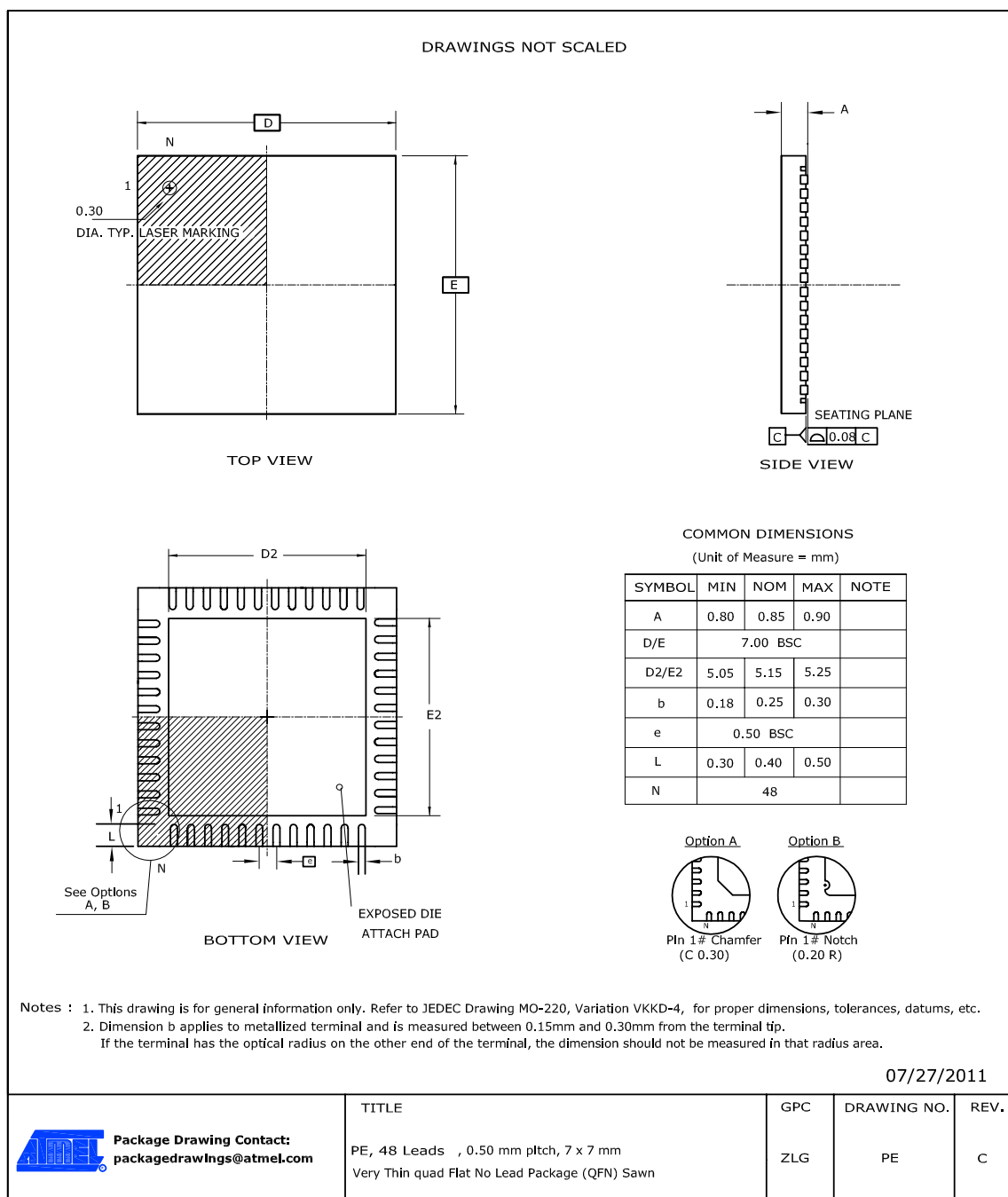
Table 8-10. Package Reference

| | |
|-------------------------|--------|
| JEDEC Drawing Reference | MO-220 |
| JESD97 Classification | E8 |

8.2.4. 48 pin TQFP



8.2.5. 48 pin QFN



Note: The exposed die attach pad is not connected electrically inside the device.

Table 8-14. Device and Package Maximum Weight

| | |
|-----|----|
| 140 | mg |
|-----|----|

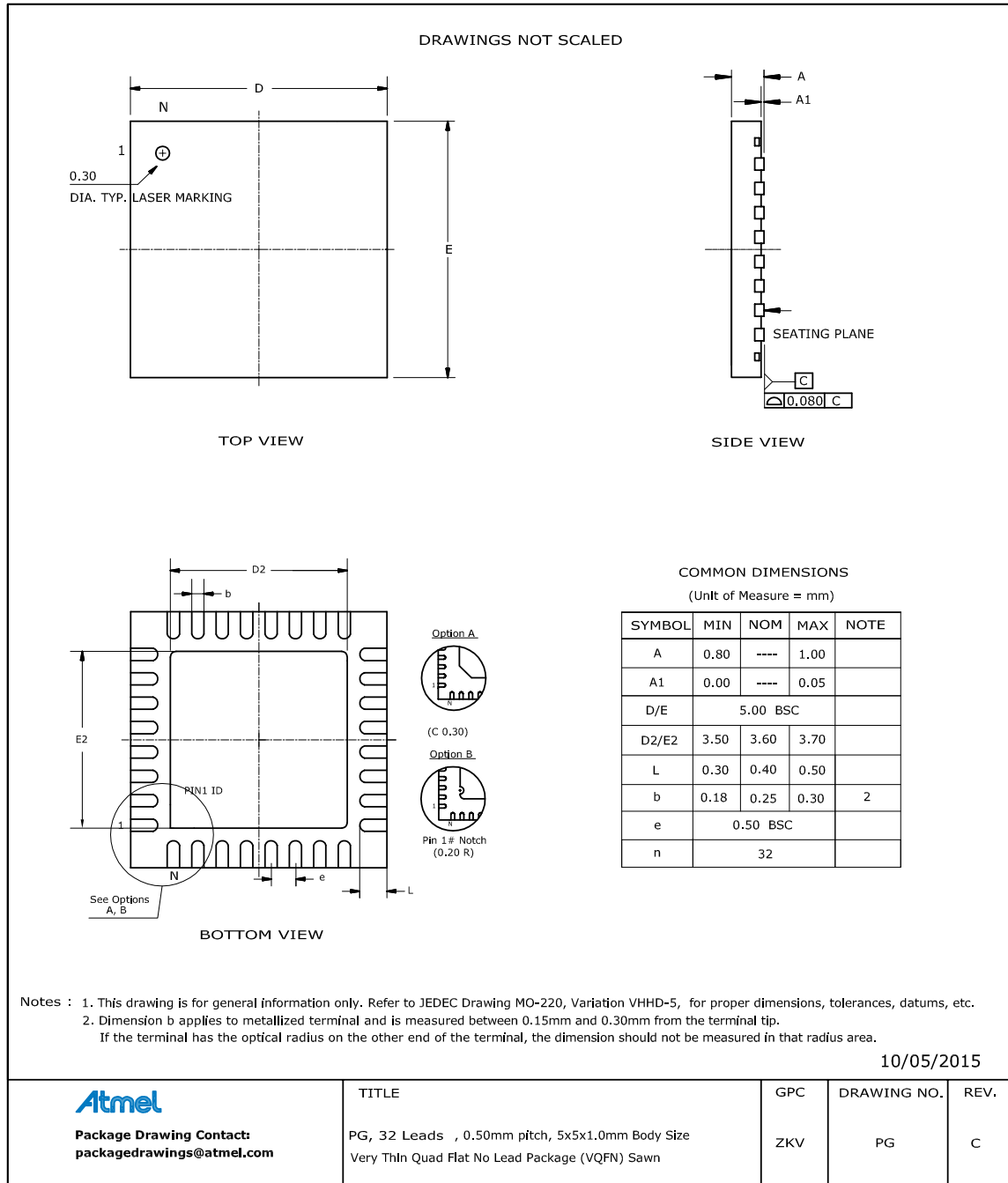
Table 8-15. Package Characteristics

| | |
|----------------------------|------|
| Moisture Sensitivity Level | MSL3 |
|----------------------------|------|

Table 8-22. Package Reference

| | |
|-------------------------|--------|
| JEDEC Drawing Reference | MS-026 |
| JESD97 Classification | E3 |

8.2.8. 32 pin QFN



Note: The exposed die attach pad is connected inside the device to GND and GNDANA.

Table 8-23. Device and Package Maximum Weight

| | |
|----|----|
| 90 | mg |
|----|----|



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